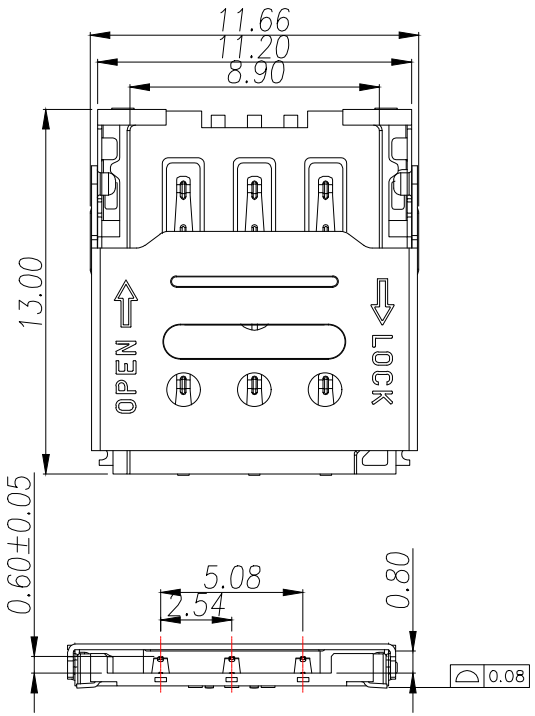
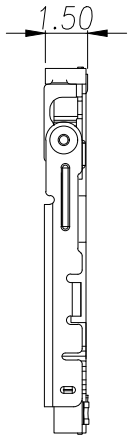
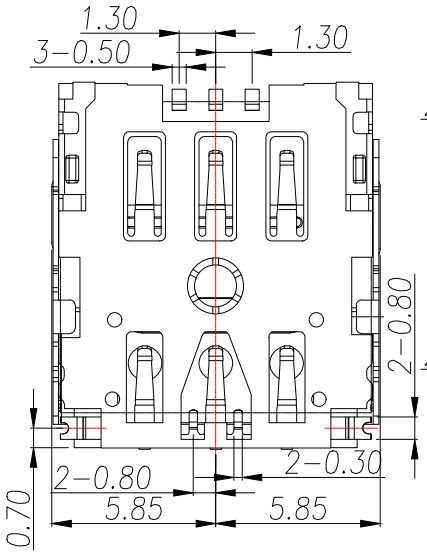
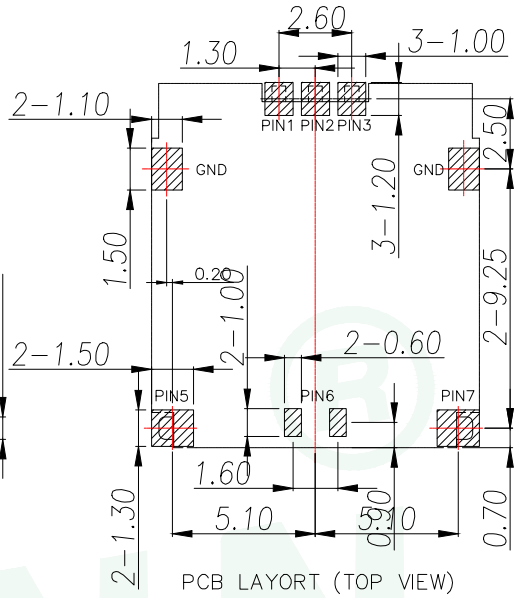
REV.	DESCRIPTION	ECN NO.	NAME	DATE





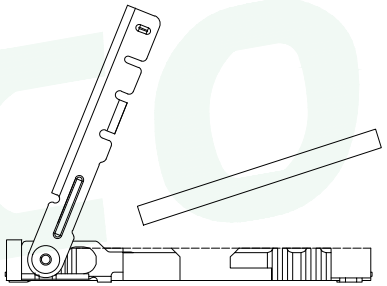




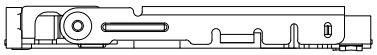
PCB LAYORT (TOP VIEW)

TOLERANCE: ±0.05

SIM CARD PIN ON	NAME
PIN_1	VCC
PIN_2	RST
PIN_3	CLK
PIN_5	GND
PIN_6	VPP
PIN_7	I/O



STEP 1 INSERT NANO SIM CARD



STEP 2 PUSH THE SHELL

NOTES:

1. MATERIAL:
   - 1-1 HOUSING: THERMOPLASTIC, UL94 V-0 . COLOR;BLACK
   - 1-2 SHELL; STAINLESS STEEL T=0.20mm
   - 1-3 CONTACT: COPPER ALLOY T=0.15mm
2. FINISH:
   - 2-1 CONTACT: 1u" AU MIN. ON CONTACT AREA
     GOLD FLASH ON SOLD AREA.
     50u" NI MIN. UNDERPLATING OVER ALL

GENERAL TOLERANCE						
DIM.	TOL.	DONGGUAN BAOXUN PRECISION TECHNOLOGY CO., LTD				BXCONN®
X		TITLE: 1.5 NANO SIM CARD CONNECTOR				
X.X	±0.30					
X.XX	±0.25	DWG. NO.: SIM303-GZ6P			DRAWN: MAX	
X.XXX	±0.15					
GENERAL ANGLE:	±3°	PART NO.: SIM303-GZ6P			CHECKED: ELLA	
		UNIT: mm	SCALE: none	SHEET: 1of 1	DWG. SIZE: A4	LAYER: bxconn	APPROVED: WILL